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Wen-Kun YANG	Name: Advanced Chip Engineering Technology Inc.
	Street Address: 65, Guangfu N. Rd. Hukov Shiang
G Additional names of conveying parties attached.	_
3. Nature of Conveyance: X Assignment ☐ Merger ☐ Security Agreement ☐ Change of Name ☐ Other:	City, State, Zip: Hsinchu, TAIWAN 303, R.O.C.
Execution Date: April 29, 2004	G Additional name(s) and address(es) attached.
4. (A) Patent Application Number(s):	4. (B) Patent Number(s):
10/835,571	
If this document is being filed together with a new application, the execution date of the application is:	
5. Name and Address of Party to whom Correspondence	6 Test Market of A. Vistonia
Concerning this Document Should be Mailed:	6. Total Number of Applications and Patents Involved: 1
Name: Gary M. Nath	7. Total Fee:
Address: NATH & ASSOCIATES PLLC 1030 15 th Street, N.W. B 6 th Floor	(37 CFR 3.41) \$ 40.00
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Mann Ball Coate: May 14, 2004	
Name of Person Signing Gafy M. Nath, Reg. No. 26,965 Marvin C. Berkowitz, Reg. No. 47,421	
Attorney Docket Na.: 26126 Customer No. 20529	
Total number of pages comprising cover sheet: 1	

CNVASG.PAT (092992)

PATENT REEL: 014633 FRAME: 0468 Nath & Associates PLLC;

202 822 9409; May-14-04 16:29; Page 2

Page 2/4

HIMARK COUNSELORS Fax:886-2-25770761

May 3 2004 18:20

P. 02/03

Page One of Two

PATENT

Attorney Docket No .: - sec-

26126

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION given to Wen-Kun Yang, hereinafter referred to as the ASSIGNOR(S), who has/have invented certain new and useful Structure of package, hereinafter referred to as the invention, for which I/we has/have-executed an application for Letters Patent to be filed in the United States Patent and Trademark Office.

WHEREAS, Advanced Chip Engineering Technology Inc., corporation organized and existing under the laws of the country/state of Taiwan, whose post office address/business address is No. 65, Guangfu N. Rd., Hukou Shiang, Hsinchu, Taiwan 303, R.O.C., hereinafter referred to as the ASSIGNEE, desires to acquire the entire right, title and interest for the United States and elsewhere throughout the world in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof.

NOW, WITNESSETH THIS that for and in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt, adequacy and sufficiency of which are hereby acknowledged, said ASSIGNOR(S) hereby assign(s), sell(s) transfer(s) to said ASSIGNEE, its assigns and legal representatives, the entire right, title and interest for the United States and elsewhere throughout the world, in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any way arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives, in as ample and as beneficial a manner for all intents and purposes as said ASSIGNOR(S) might or could have held and enjoyed the same had this assignment not been made.

> PATENT REEL: 014633 FRAME: 0469

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202 822 9409; May-14-04 16:30; Page 3

Page 3/4

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May 3 2004 18:20

P. 03/03

Page Two of Two

Attorney Docket No .: -

26126

ASSIGNMENT

ALSO, said ASSIGNOR(S) hereby agree(s) to execute all papers necessary to file said applications in the United States and elsewhere throughout the world, and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing any and all Letters Patent thereon.

said ASSIGNOR(S) authorize(s) and request(s) Commissioner of Patents to issue a Letters Patent on said application. and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

Bv:

Inventor's Name: Wen-Kun Yang

(first or first inventor)

April 29, 2004

Date

PATENT REEL: 014633 FRAME: 0470

RECORDED: 05/14/2004